SEIKO EPSON CORPORATION

CRYSTAL OSCILLATOR (Programmable) OUTPUT: CMOS





Product Number

SG-8101CG: X1G005181xxxx00 SG-8101CE: X1G005211xxxx00 SG-8101CB: X1G005201xxxx00 SG-8101CA: X1G005191xxxx00

SG-8101 series

• Frequency range : 0.67 MHz to 170 MHz (1 × 10⁻⁶ Step)

• Supply voltage : 1.62 V to 3.63 V

• Function : Output enable (OE) or Standby (\overline{ST})

• Frequency tolerance : $\pm 15 \times 10^{-6}$ (-40 °C to +85 °C)

 $\pm 20 \times 10^{-6}$, $\pm 50 \times 10^{-6}$ (-40 °C to +105 °C)

• PLL technology to enable short lead time

• Available field oscillator programmer "SG-Writer II"







2.5 × 2.0 mm 3.2 × 2.5 mm

5.0 × 3.2 mm

7.0 × 5.0 mm

Specifications (characteristics)

Specifica	itions (cnarac	teristics)							
Ite	Item Symbol		Specifications				Co	nditions/Remarks	
Supply voltage		Vcc	1.80	V Тур.	2.50 V Typ.	3.30 V Typ.			
		VCC	1.62 V to 1.98 V	1.98 V to 2.20 V	2.20 V to 2.80 V	2.70 V to 3.63 V			
Output frequer	ncy range	fo	0.67 MHz to 170 MHz						
Storage tempe	rature range	T_stg			+125 °C		Storage as single p	oroduct.	
Operating tem	nerature range	T use		-40 °C to +85 °C				-	
Operating temperature range		ı_use	-40 °C to +105 °C						
			B: ±15 × 10 ⁻⁶			T_use = -40 °C to -			
Frequency tolerance*1		f_tol	C: ±20 × 10 ⁻⁶				T_use = -40 °C to -		
				J: ±50 × 10 ⁻⁶			T_use = -40 °C to +105 °C		
			3.2 mA Max.	3.3 mA Max.	3.4 mA Max.	3.5 mA Max.	T_use = +105 °C	No load, fo = 20 MHz	
Current consur	mption	Icc		тА Тур.	2.9 mA Typ.	3.0 mA Typ.	T_use = +25 °C	140 1044, 10 - 20 IVII 12	
		100	5.5 mA Max.	5.8 mA Max.	6.7 mA Max.	8.1 mA Max.	T_use = +105 °C	No load, f ₀ = 170 MHz	
				тА Тур.	5.7 mA Typ.	6.8 mA Typ.	T_use = +25 °C	, -	
Output disable	current	I_dis	3.2 mA Max.	3.2 mA Max.	3.3 mA Max.	3.5 mA Max.	OE = GND, f_0 = 17	0 MHz	
Standby currer	nt	I std	0.9 μA Max.	1.0 μA Max.	1.5 μA Max.	2.5 μA Max.	T_use = +105 °C	ST = GND	
,		_	0.3 μA Typ.	0.4 μA Typ.	0.5 μA Typ.	1.1 μA Typ.	T_use = +25 °C	S. 5.45	
Symmetry		SYM		45 % 1	io 55 %		50 % V _{CC} Level		
Output voltage (DC characteristics)		V _{ОН}	90 % V _{CC} Min.			Rise/Fall time Default (fo > 40 MHz) Fast Default (fo ≤ 40 MHz)	I _{OL} 2.5 3.5 4.0 5.0		
		VoL		10 % V	cc Max.	Slow *A: 1.6	IoL 1.5 2.0 2.5 3.0 IoH -1.0 -1.5 -2.0 -2.5 IoL 1.0 1.5 2.0 2.5 62 V to 1.98 V, *B: 1.98 V to 2.20 V 20 V to 2.80 V, *D: 2.70 V to 3.63		
Output load co	ndition	L_CMOS	15 pF Max.				-		
		V _{IH}	70 % V _{CC} Min.						
Input voltage		VIL	30 % V _{CC} Max.				OE or ST		
	Defeult		3.0 ns Max.			f _O > 40 MHz			
Rise time /Fall time	Default	tr/tf	6.0 ns Max.			f ₀ ≤ 40 MHz	20 % - 80 % V _{CC} .		
	Fast		3.0 ns Max.			f ₀ = 0.67 MHz to 170 MHz f ₀ = 0.67 MHz to 20 MHz			
	Slow		10.0 ns Max.						
Output disable time (OE) Output disable time (ST)		tstp_oe tstp_st	1 μs Max.			Measured from the V _{CC}	e time OE or ST pin crosses 30 %		
Output enable time (OE)		tsta_oe	1 μs Max.			Measured from the	e time OE pin crosses 70 % V _{CC}		
Output enable time (ST)		tsta_st	3 ms Max.			Measured from the	time ST pin crosses 70 % Vcc		
Start-up time		t_str	3 ms Max.			Measured from the minimum value, 1.6	e time V _{CC} reaches its rated 62 V		
Frequency aging		f age	This is included in frequency tolerance specification.			+25 °C, first year			

Frequency aging f_age This is included in frequency tolerance specification. +25 °C, first year

*1 Frequency tolerance includes initial frequency tolerance, frequency / temperature characteristics, frequency / voltage coefficient, frequency / load coefficient and frequency aging (+25 °C, 1 year).

Pin description

	·	1				
Pin	Name	I/O type		Function		
	OE	Input	Output enable	High*2: Specified frequency output from OUT pin		
				Low: Out pin is low (weak pull down), only output driver is disabled.		
1		Input	Standby	High*2: Specified frequency output from OUT pin		
	ST			Low: Out pin is low (weak pull down),		
				Device goes to standby mode. Supply current reduces to the least as I_std.		
2	GND	Power	Ground			
3	OUT	Output	Clock output			
4	V _{cc}	Power	Power supply			

^{*2} Please do not use the OE/ST terminal in the open state.



Product Name

SG-8101CG 25.000000MHz <u>TCHPA</u> 45678

1)Model 2)Package type

③Frequency ④Supply voltage (T: 1.8 V to 3.3 V Typ.)

⑤Frequency tolerance ⑥Operating temperature

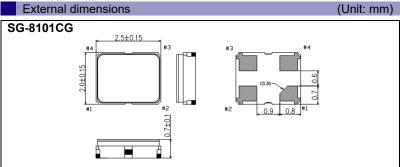
7 Function 8 Rise/Fall time

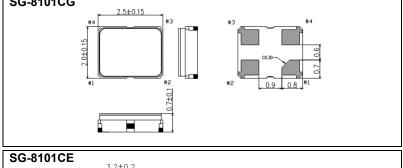
②Package type			
CG	2.5 mm × 2.0 mm		
CE	3.2 mm × 2.5 mm		
СВ	5.0 mm × 3.2 mm		
CA	7.0 mm × 5.0 mm		

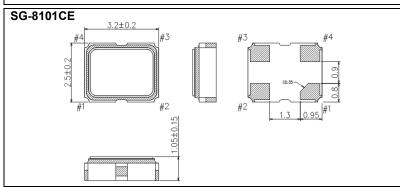
⑤Frequency tolerance / ⑥Operating temperature				
BG	±15 × 10 ⁻⁶ / -40 °C to +85 °C			
СН	±20 × 10 ⁻⁶ / -40 °C to +105 °C			
JH	±50 × 10 ⁻⁶ / -40 °C to +105 °C			

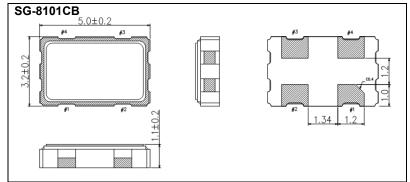
⑦Function				
Р	Output enable			
S	Standby			

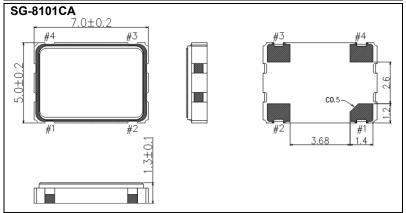
®Rise time/Fall time			
Α	Default		
В	Fast		
С	Slow		

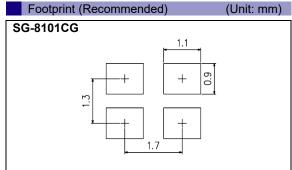


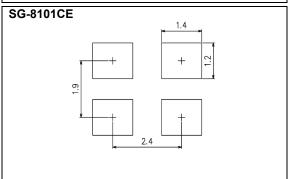


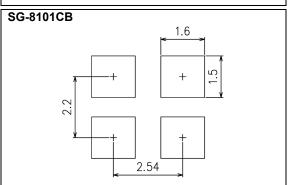


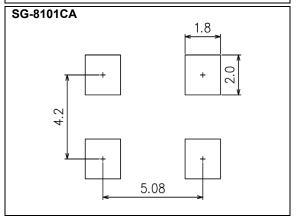












■Notes:

In order to achieve optimum jitter performance, the 0.1 µF capacitor between V_{CC} and GND should be placed. It is also recommended that the capacitors are placed on the device side of the PCB, as close to the device as possible and connected together with short wiring pattern.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

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Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.





▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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